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		06-16d	App. 11-28-06	

**Curriculum Proposal Cover Sheet - University-Wide Undergraduate Curriculum Committee**

Contact Person Dr. Devki N. Talwar	Email Address talwar@iup.edu
Proposing Department/Unit Physics/NSM	Phone 7-2190

Check all appropriate lines and complete information as requested. Use a separate cover sheet for each course proposal and for each program proposal.

<b>1. Course Proposals (check all that apply)</b> <input type="checkbox"/> New Course <input type="checkbox"/> Course Prefix Change <input type="checkbox"/> Course Deletion <input checked="" type="checkbox"/> Course Revision <input type="checkbox"/> Course Number and/or Title Change <input type="checkbox"/> Catalog Description Change		
<i>Current Course prefix, number and full title</i>		<i>Proposed course prefix, number and full title, if changing</i>
<b>2. Additional Course Designations: check if appropriate</b> <input type="checkbox"/> This course is also proposed as a Liberal Studies Course. <input type="checkbox"/> Other: (e.g., Women's Studies, Pan-African) <input type="checkbox"/> This course is also proposed as an Honors College Course.		
<b>3. Program Proposals</b> <input type="checkbox"/> New Degree Program <input type="checkbox"/> Program Title Change <input type="checkbox"/> Other <input type="checkbox"/> New Minor Program <input type="checkbox"/> New Track <input type="checkbox"/> Catalog Description Change <input type="checkbox"/> Program Revision		
<i>Current program name</i>		<i>Proposed program name, if changing</i>
<b>4. Approvals</b>		<b>Date</b>
Department Curriculum Committee Chair(s)	<i>Kenneth E Hershman</i>	<i>9/13/06</i>
Department Chair(s)	<i>Kenneth E Hershman</i>	<i>9/13/06</i>
College Curriculum Committee Chair	<i>[Signature]</i>	<i>09/18/06</i>
College Dean	<i>Sue Ann Beach</i>	<i>10/5/06</i>
Director of Liberal Studies *		
Director of Honors College *		
Provost *		
Additional signatures as appropriate: (include title)		
<b>Received</b> UWUCC Co-Chairs	<b>Received</b> <i>Gail Sedquist</i>	<i>11-28-06</i>

*\* where applicable* **OCT - 6 2006**

**NOV 28 2006**

### 3. NMTT 313 Thin Films in Nanofabrication

#### I. Catalog Description

NMTT313 Thin Films in Nanofabrication

3c-21-3cr

Corequisite: Admission to NMT track

Provides a detailed understanding of the use and processing of thin film materials in nanofabrication. Emphasizes the understanding and operation of the state-of-the-art deposition and etching processing equipment in the PSU Nanofabrication Cleanroom Facility.

#### II. Course objectives

Students will be able to

- A. Demonstrate an understanding of various chemical vapor deposition (CVD) processes; describe similarities and differences of equipment used to grow materials for devices in nanofabrication: PECVD, LPCVD, Atmospheric Pressure Chemical Vapor Deposition (APCVD), Electron Cyclotron Resonance (ECR).
- B. Demonstrate an understanding of the basic operations of CVD equipment; describe the applications of different CVD grown thin films for devices in nanofabrication.
- C. Identify different physical vapor deposition (PVD) processes; describe similarities and differences of various equipment and tools used to prepare thin films; setting up and operating equipment such as a) Magnetron sputtering and b) Thermal and e-gun Evaporator to understand PVD thin film growth processes in nanofabrication.
- D. Demonstrate an understanding of the RIE processes; describe similarities and differences of various RIE equipment used in nanofabrication: Parallel plate RIE, Magnetically enhanced (ME) RIE, ECR RIE, ICP RIE, TCP RIE, and triode.
- E. Explain the 'wet chemical etching' processes; describe similarities and differences of equipment and materials used for wet etching in nanofabrication; setting up equipment such as 'automated wet bench baths' to perform wet chemical etching.
- F. Demonstrate an understanding of all the 'plasma etching' processes and techniques; describe similarities and differences of equipment and materials used for plasma etching in nanofabrication; setting up 'Plasma therm 720' to perform plasma etching.
- G. Demonstrate an understanding of 'self-assembly' in nanofabrication; describe the steps needed in the atomic level development of defect-free, self-healing chemical and biological materials and structures in nanofabrication.
- H. Operate a scanning electron microscope (Lieca 440 SEM) for materials characterization used in nanofabrication.

#### III. Course Outline

This course is designed to give students experience in depositing and etching a wide variety of materials including dielectrics, semiconductors, organics, polymers, metallic materials and molecular films. Lectures are generally presented for 3 hours for 4 days/week and lab sessions for 3 hours for 3 or 4 days/week in the fall and spring semester. During summers, lectures and labs are held for 5 days/week.

Part A: Lecture, group project (30 hours)

In this course the students learn about the link concepts of thin films to hardware on process tools - analyzing processing tool parameters and their effect on thin film growth; advanced plasma technology for processing; dry etch/ DC bias/ polymers for sidewalls; common plasma chemistry for etch; algorithms for dry etch analysis; high density plasma systems etc.

### Part B: Lab (18 hours)

The students will be engaged in an in-depth, hands-on exposure to deposition by using several approaches including PVD, CVD, and self-assembly; and to the etching by using variety of methods such as wet and dry etching techniques commonly used in the Nanofabrication.

Students work in small teams in the labs to gain hands-on experience. They also participate in the oral and written report activities. The first part of this lab course covers film deposition and advanced plasma technology for processing. Deposition techniques used in the studies include self-assembly; colloidal chemistry; atmosphere, low-pressure and plasma enhanced chemical vapor deposition; sputtering; thermal and electron beam evaporation; nebulization and spin-on. The second part of the course focuses on film removal by using advanced etching processes with emphasis on reactive ion etching, high-density plasma systems (ECR, MERIE, ICP, TCP, triode), ion beam etching, and wet chemical etching, etc.

## IV. Evaluation method

The final grade will be determined as follows

Mid-term exam (500 points)

Quizzes (usually 3 quizzes each of 100 points = 300 points)

Lab + homework (400 points)

Independent reports and simulation (250 points)

Final presentation (300 points)

Final Exam (500 points optional)

## V. Example Grading Scale

The final grade will be determined by the following percent scale.

90% - 100% - A

80% - 89% - B

70% - 79% - C

60% - 69% - D

below 60% - F

## VI. Attendance Policy

Attendance is mandatory. Make up time is required for any absence that extends beyond two days. The student must give a written explanation for absences. An attendance sheet is attached to the classroom door, and the missed time must be documented before re admittance to the class. Failure to make up lab time results in an F grade.

## VII. Required Textbook(s), Supplemental Books and Readings

1. *Semiconductor Manufacturing Technology* by Michael Quirk and Julian Serda (2001) [Prentice-Hall : ISBN 0-13-081520-9]
2. *Nanotechnology A gentle introduction to the next big Idea* by Mark Ratner, Daniel Ratner (2003) [Prentice Hall : ISBN 0-13-101400-5]
3. Nanofab Safety Manual

4. Class notes in printed form
5. Notes issued during class
6. Equipment training notes
7. Lab experiment notes

## VIII. Special Resources Requirements

There is no special resource requirements for this course

## IX. Bibliography

### Books

1. *Nanotechnology: A Gentle Introduction to the Next Big Idea*, by Mark A Ratner *et al.* (Pearson, Education, Inc. 2003).
2. *The Next Big Thing Is Really Small: How Nanotechnology Will Change the Future of Your Business* by Jack Uldrich (Crown Business, 2003).
3. *Our Molecular Future: How Nanotechnology, Robotics, Genetics and Artificial Intelligence Will Transform Our World* by Douglas Mulhall (Prometheus 2002).
4. *Understanding Nanotechnology* by editors at The Scientific American (2002).
5. *Introduction to Nanotechnology*, by Charles P. Poole, Frank J. Owens (Wiley 2003).
6. *Nanotechnology: Basic Science and Emerging Technologies* Edited by Michael Wilson, Kamali Kannangara, Geoff Smith, Michelle Simmons (Chapman and Hall 2002)
7. *Engines of Creation : The Coming Era of Nanotechnology*, by Eric Drexler (Anchor 1990).

### Popular Articles

*It's a Small World After All* by Lawrence D. Maloney, Design News Sep 26, 2005  
*Nanotech could put a new spin on sports* by Kevin Maney, USA Today, Nov 17 2004.  
*Nanomechanical memory demoeed* by Eric Smalley TRN, Nov 15, 2004

## COURSE ANALYSIS QUESTIONNAIRE

### Section A: Details of the Course

- A1 *How does this course fit into the programs of the department? For what students is the course designed? (majors, students in other majors, liberal studies). Explain why this content cannot be incorporated into an existing course.*

The course will extend knowledge learned in other departmental courses to areas that are currently the subjects of cutting-edge research and technology. The course is designed for the Applied Physics majors who have been admitted to NMT track. This content cannot be incorporated into an existing course because the department currently does not have necessary equipment and facility. Also, the content covers a broad range of topics in physics chemistry and interface areas such as biology, biochemistry, material science, and forensics. There are no physics courses in which all of these topics could be included.

- A2 *Does this course require changes in the content of existing courses or requirements for a program? If catalog descriptions of other courses or department programs must be changed as a result of the adoption of this course, please submit as separate proposals all other changes in courses and/or program requirements.*

The course **does not** require changes in the content of existing courses or requirements.

- A3 *Has this course ever been offered at IUP on a trial basis (e. g. as a special topic). If so, explain the details of the offering (semester/year and number of students).*

The course has **never been offered** on a trial basis.

- A4 *Is this course to be a dual-level course? If so, please note that the graduate approval occurs after the undergraduate.*

No, it is not dual-level.

- A5 *If this course may be taken for variable credit, what criteria will be used to relate the credits to the learning experience of each student? who will make this determination and by what procedures?*

The course is not variable credit.

- A6 *Do other higher education institutions currently offer this course? If so, please list examples (institution, course title).*

Yes, similar courses are being taught at several other PASSHE universities including Lock Haven, Shippensburg, California, Millersville, Clarion, etc.

- A7 *Is the content, or are the skills, of the proposed course recommended or required by a professional society, accrediting authority, law or other external agency? If so please provide documentation.*

No

## **Section B: Interdisciplinary Implications**

- B1 *Will this course be taught by instructors from more than one department? If so, explain the teaching plan, its rationale, and how the team will adhere to the syllabus of record.*

This course will be taught only at the Penn State's NMT facility.

- B2 *What is the relationship between the content of this course and the content of courses offered by other departments? Summarize your discussions (with other departments) concerning the proposed changes and indicate how any conflicts have been resolved. Please attach relevant memoranda from these departments that clarify their attitudes toward the proposed change(s).*

The content of this course is not related to courses given in other departments.

- B3 *Will this course be cross-listed with other departments? If so, please summarize the department representatives' discussions concerning the course and indicate how consistency will be maintained across departments.*

The course will not be cross-listed with other departments.

## **Section C: Implementation**

C1 *How will the proposed new track affect students already in the existing program?*

The essence of the Applied Physics/NMT track is to help students in their Junior/Senior year to gain valuable experience (18 cr. Capstone 16 weeks (Fall or Spring) or 12 weeks (Summer)) in nanofabrication manufacturing technology at the Penn State' Nanofabrication Facility while enrolled for the BS degree in Applied Physics at Indiana University of Pennsylvania. Students taking the capstone experience at Penn State will pay tuition for the 18 credits at IUP at the prevailing rate while Penn State will provide, through agreement with the State of Pennsylvania, the necessary boarding and lodging. The 18 credits earned by the students at Penn State will be transferred to IUP in compliance with the agreement between Penn State and PASSHE. Other students in the IUP physics program will not be affected at all.

C2 *Are faculty resources adequate? If you are not requesting or have not been authorized to hire additional faculty, demonstrate how these courses will fit into the schedule(s) of current faculty. What will be taught less frequently or in fewer sections to make this possible?*

Since capstone experience in nanofabrication manufacturing technology will take place at the Penn State' Nanofabrication Facility, no new faculty at IUP will be needed to offer this new track and no change in other courses or programs in the physics department is foreseen.

C3 *Are other resources adequate? (Space, equipment, supplies, travel funds)*

- (a) No additional space is necessary to offer this new track
- (b) No additional supplies are necessary for this new track
- (c) No additional equipment is needed for this new track
- (d) Available library materials are adequate for this new track.
- (e) No travel funds are needed.

C4 *Do you expect an increase or decrease in the number of students as a result of these revisions? If so, how will the department adjust?*

Although the number of students in this track might not significantly increase the total number of students in the Applied Physics Program, it is expected that the NMT track may help attract highly motivated undergraduates into our program.

C5 *Intended implementation date (semester and year)*

The new track is expected to start as soon as it is approved. Intended implementation date is Fall 2006. Students in the Applied Physics Program with NMT track will be advised in a manner consistent with university procedures for phasing in of the 120 curricula.

## **Section D: Miscellaneous**

D1 Include any additional information valuable to those reviewing this new course proposal.

N/A